

MBR30L60FCTW

List

List.....	1
Package outline.....	2
Features.....	2
Mechanical data.....	2
Maximum ratings	2
Electrical characteristics.....	2
Rating and characteristic curves.....	3
Pinning information.....	4
Marking.....	4
Tube packing.....	4
Suggested thermal profiles for soldering processes.....	5
High reliability test capabilities.....	6

MBR30L60FCTW

30A Power Low VF
Schottky Barrier Rectifiers 60V

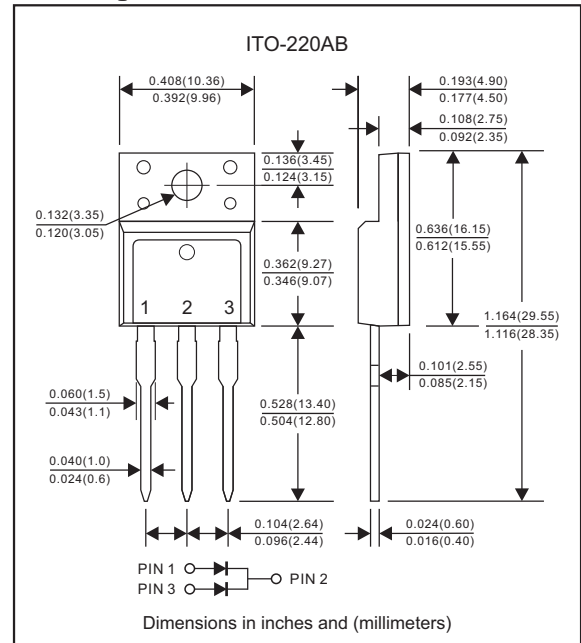
Features

- High current density schottky.
- 150°C operating junction temperature.
- Offer 15A half wave and 30A full wave rectification.
- Low power loss, high efficiency.
- Low forward voltage drop.
- High current capability
- High surge capability.
- Guardring for overvoltage protection.
- Low stored charge majority carrier conduction
- Lead-free parts meet RoHS requirements.
- Suffix "-H" indicates Halogen-free part, ex. MBR30L60FCTW-H.

Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : Approximated 1.70 gram

Package outline



Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR30L60FCTW	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	60	Volts
Maximum RMS voltage	V_{RMS}	42	Volts
Maximum DC blocking voltage	V_{DC}	60	Volts
Maximum average forward rectified current per device per diode	I_O	30 15	A
Peak forward surge current 8.3ms single half sine-wave	I_{FSM}	200	A
Operating junction temperature range	T_J	-55 to +150	$^\circ\text{C}$
Storage temperature range	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR30L60FCTW	Unit
Maximum forward voltage per diode at $I_F=15\text{A}$	V_F	0.60	Volts
Maximum reverse current at rated V_{DC} per diode	I_R	0.1 15	mA
		$T_A=25^\circ\text{C}$	
		$T_A=125^\circ\text{C}$	

Thermal characteristics

PARAMETER	Symbol	MBR30L60FCTW	Unit
Typical thermal resistance	$R_{\theta JC}$	2.5	$^\circ\text{C/W}$

Rating and characteristic curves (MBR30L60FCTW)

Fig.1 FORWARD CURRENT DERATING CURVE

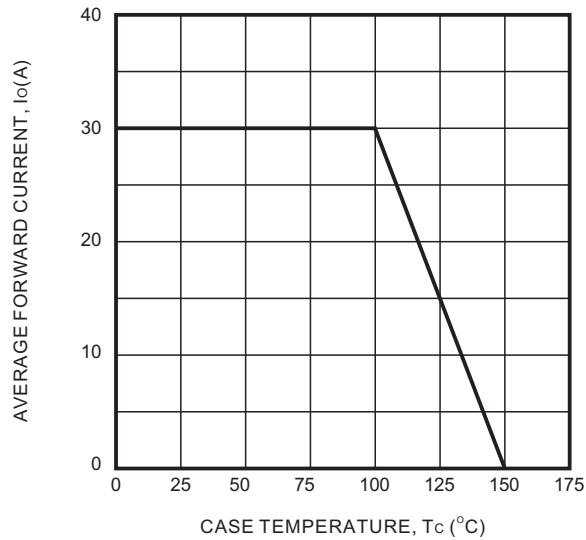


Fig.2 TYPICAL FORWARD CHARACTERISTICS

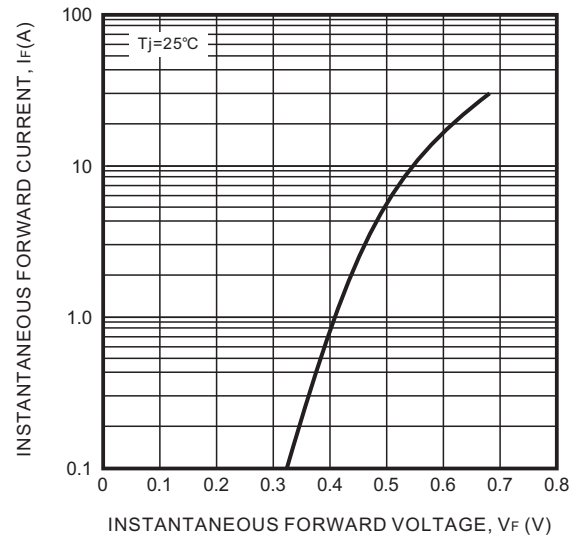


Fig.3 MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

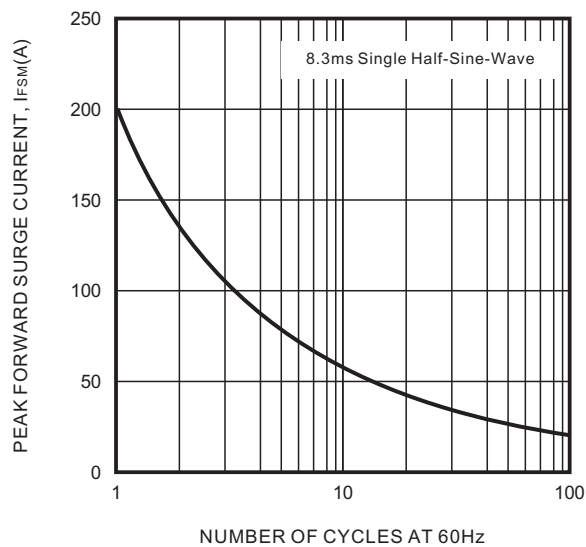
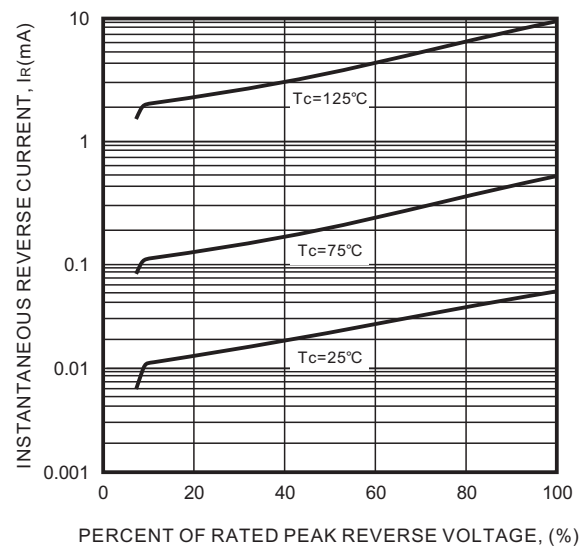
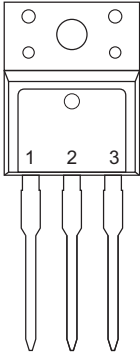
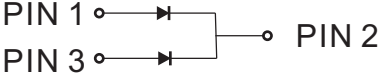


Fig.4 TYPICAL REVERSE CHARACTERISTICS



MBR30L60FCTW

Pinning information

Pin	Simplified outline	Symbol
Pin1 anode Pin2 cathode Pin3 anode		

Marking

Type number	Marking code
MBR30L60FCTW	MBR30L60FCTW

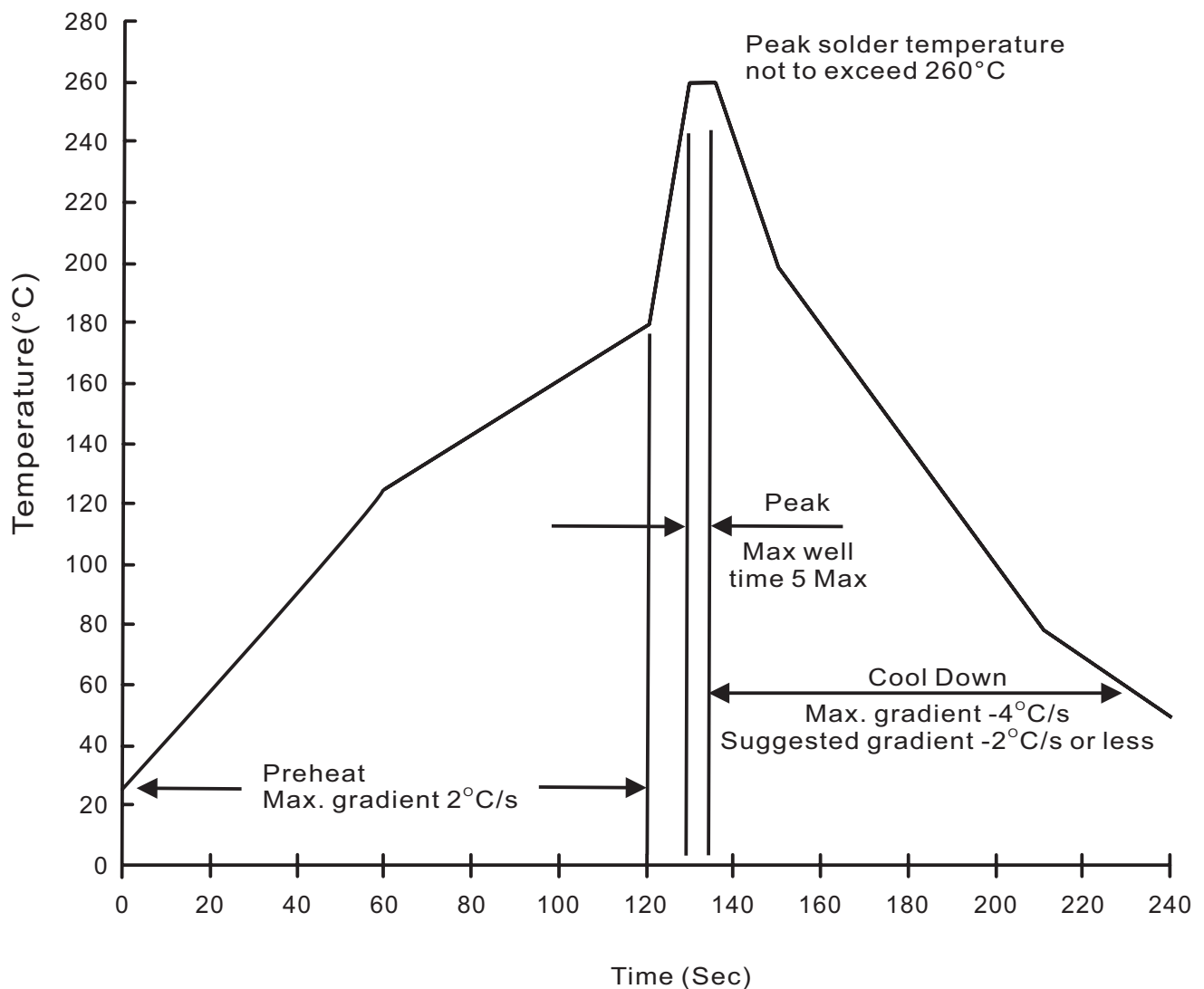
Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
ITO-220AB	50	525*31.9*6.4	1000	545*150*45	575*245*170	5,000	15.0

MBR30L60FCTW

Suggested thermal profiles for soldering processes

1. Lead free temperature profile wave-soldering



MBR30L60FCTW

High reliability test capabilities

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm5^{\circ}\text{C}$ for $10\pm2\text{sec.}$ immerse body into solder $1/16''\pm1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$, $I_F = I_O$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A=85^{\circ}\text{C}$, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at 150°C for 1000 hrs.	MIL-STD-750D METHOD-1031